

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	2EDL23N06PJ	**Issued**	08. April 2022
MA#	MA005583924		
Package	PG-DSO-14-70	**Weight***	138.49 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.871	1.35	1.35	13507	13507
leadframe	inorganic material	phosphorus	7723-14-0	0.014	0.01		104	
	non noble metal	zinc	7440-66-6	0.057	0.04		415	
	non noble metal	iron	7439-89-6	1.150	0.83		8300	
	non noble metal	copper	7440-50-8	46.675	33.70	34.58	337018	345837
wires	noble metal	palladium	7440-05-3	0.001			7	
	non noble metal	copper	7440-50-8	0.093	0.07	0.07	670	677
encapsulation	organic material	carbon black	1333-86-4	0.345	0.25		2493	
	plastics	epoxy resin	-	12.516	9.04		90374	
	inorganic material	silicondioxide	60676-86-0	73.457	53.04	62.33	530401	623268
leadfinish	non noble metal	tin	7440-31-5	1.226	0.89	0.89	8853	8853
plating	noble metal	silver	7440-22-4	0.307	0.22	0.22	2213	2213
glue	plastics	acrylic resin	-	0.172	0.12		1242	
	noble metal	silver	7440-22-4	0.610	0.44	0.56	4403	5645
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com